

### Description

The CL9195 series are high ripple rejection, low power consumption, low dropout CMOS step-down voltage regulators with over-current and short circuit protection. These devices have very low quiescent bias current (60 $\mu$ A Typ.), they can deliver 500mA of output current with very small input and output voltage differences, and still maintain good regulation. Due to the small voltage difference between the input and output and the low quiescent bias current, these devices are especially suitable for battery-operated products such as computers, consumer products and industrial equipment, which want to prolong the useful battery life.

### Feature

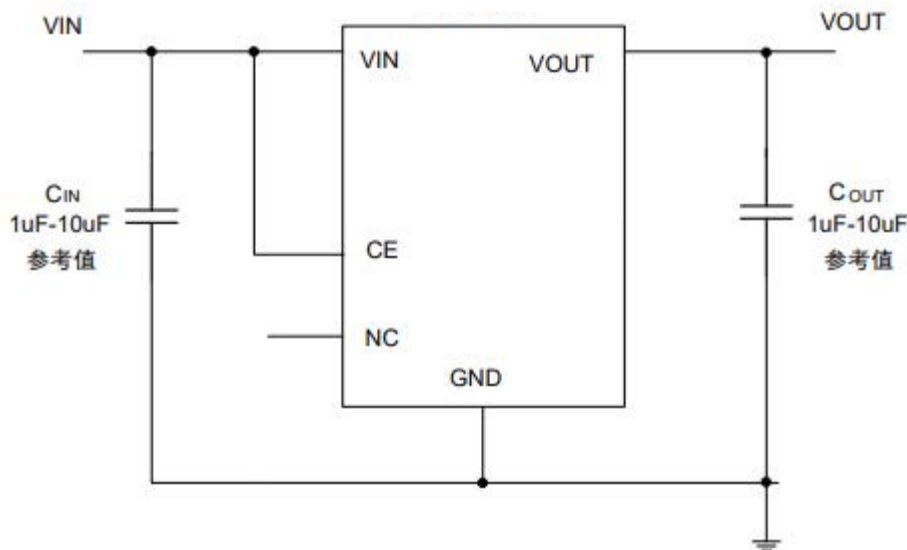
- ◆ Output Voltage Range: 1.2V-5.0V
- ◆ I<sub>o</sub>(max) : 500mA
- ◆ PSRR: 75dB/1KHz
- ◆ Stand-by Current : 60 $\mu$ A (Typ)
- ◆ Shunt-Down Current : 1 $\mu$ A (max)
- ◆ Operating Temperature Range : -40 °C ~ +85 °C

### Applications

- ◆ CDMA / GSM
- ◆ PDAS/MP3
- ◆ WLAN/Bluetooth
- ◆ Portable Device
- ◆ Battery Power System

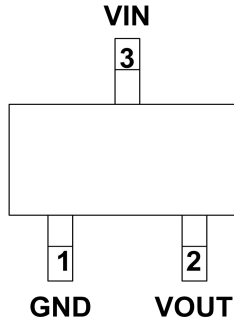
Package Type : SOT23-3L / SOT-23-5L

### Application Circuit

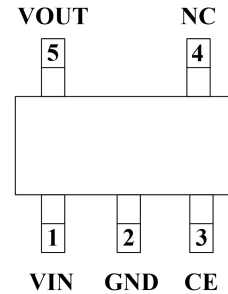


### Pin Description

**SOT-23-3L**



**SOT-23-5L**



No SOT23-3L	No SOT23-5L	Name	Description
3	1	VIN	Power Supply
1	2	GND	Ground
	3	CE	Enable
	4	NC	No Connect
2	5	VOUT	Output

### Marking Information

Part Number	Package Type	Marking
CL9195A12L3M	SOT23-3L	HF=E**
CL9195A13L3M	SOT23-3L	ZU=E**
CL9195A15L3M	SOT23-3L	WG=J**
CL9195A18L3M	SOT23-3L	XB=N**
CL9195A25L3M	SOT23-3L	WH=U**
CL9195A27L3M	SOT23-3L	WK=F**
CL9195A28L3M	SOT23-3L	XD=U**
CL9195A29L3M	SOT23-3L	WN=C**
CL9195A30L3M	SOT23-3L	WW=P**
CL9195A33L3M	SOT23-3L	WA=E**
CL9195A12L5M	SOT23-5L	WE=F**
CL9195A13L5M	SOT23-5L	ZU=D**
CL9195A15L5M	SOT23-5L	WG=H**
CL9195A18L5M	SOT23-5L	XB=L**
CL9195A25L5M	SOT23-5L	WH=M**
CL9195A27L5M	SOT23-5L	WK=E**
CL9195A28L5M	SOT23-5L	XD=R**
CL9195A29L5M	SOT23-5L	WN=B**
CL9195A30L5M	SOT23-5L	WW=S**
CL9195A33L5M	SOT23-5L	WJ=K**
CL9195A36L5M	SOT23-5L	WA=C**

### Absolute Maximum Ratings

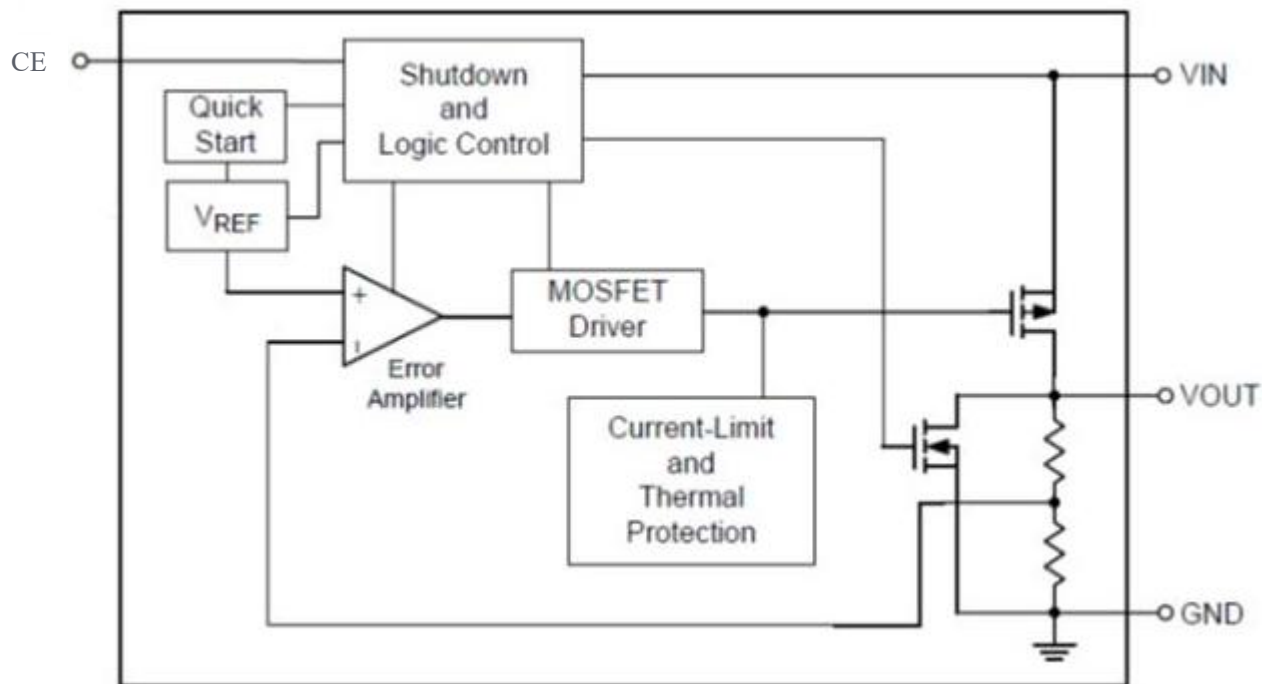
Parameter	Symbol	Rating	Unit
Input Voltage	$V_{IN}$	7	V
Output Current	$I_{out}$	600	mA
Output Voltage	$V_{out}$	$V_{ss}-0.3 \sim V_{out}+0.3$	V
Operating Temp	$T_{Opr}$	-40 ~ +85	°C
Storage Temp	$T_{stg}$	-55 ~ +125	°C
Lead Temp	$T_{solder}$	260°C, 10s	°C

**Note :** Exceeding the " **Absolute Maximum Ratings** " may damage the device. The device will operate within the recommended operating range, but its characteristics are not guaranteed. Exposure to absolute extreme parameter conditions for extended periods of time may affect device reliability.

### Power Dissipation

Package Type	$P_d$ (mW)
SOT-23-5L	300
SOT-23-3L	250

### Block Diagram



### Electrical Characteristics

( $V_{IN}=5V$ ,  $T_A = 25^{\circ}C$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Output Voltage	$V_{OUT(E)}$ (Note 2)	$I_{OUT}=40mA$ , $V_{IN}=V_{out}+1V$	X 0.98	$V_{OUT(T)}$ (Note 1)	X 1.02	V
Input Voltage	$V_{IN}$				5.5	V
Maximum Output Current	$I_{OUT(max)}$	$V_{IN}=V_{out}+1V$		500		mA
EN starting voltage	$V_{CE\_ON}$ (Note 3)		1.1			V
EN off voltage	$V_{CE\_OFF}$				0.4	V
Load Regulation	$\Delta V_{OUT}$	$V_{IN}=V_{out}+1V$ , $1mA \leq I_{OUT} \leq 100mA$		50		mV
Dropout Voltage (Note 3)	$V_{dif1}$	$I_{OUT} = 100mA$		100		mV
	$V_{dif2}$	$I_{OUT} = 200mA$		300		mV
Stand-by Current	$I_{SS}$	$V_{IN}=V_{out}+1V$		60		$\mu A$
Shunt-down Current	$I_{CEL}$	$V_{ce} = 0V$		1		$\mu A$
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot V_{OUT}}$	$I_{OUT} = 40mA$ $V_{out}+1V \leq V_{IN} \leq 8V$		0.03		%/V
Output Noise Voltage	en	$I_{OUT} = 40mA$ , 300Hz~50kHz		50		$\mu V_{rms}$
Power Supply Rejection Ration	PSRR	$V_{in} = [V_{out}+1]V$ $+1V_{p-pAC}$ $I_{OUT} = 40mA, f=1kHz$		75		dB

**Note:** 1、  $V_{OUT(T)}$  : Specified output voltage

2、  $V_{OUT(E)}$  : Effective output voltage (that is, the output voltage when  $V_{IN} = (V_{OUT(T)}+1.0V)$  when  $I_{OUT}$  remains at a certain value.

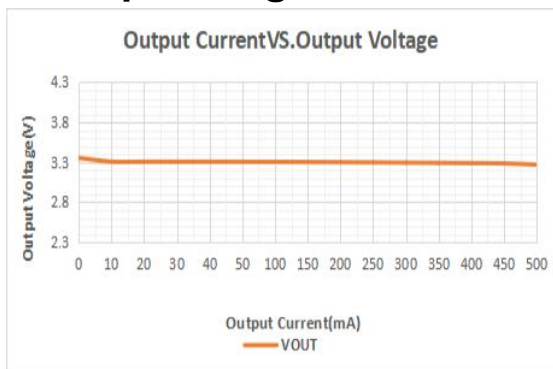
3、  $V_{CE}$  : Considering the high and low temperature and process deviation, it is recommended that customers set the enable voltage of CE PIN to 1.1V with a margin.  
There is a built-in 1M $\Omega$  resistor between CE PIN and GND PIN inside the chip.

3、  $V_{dif} : V_{IN1} - V_{OUT(E)}$

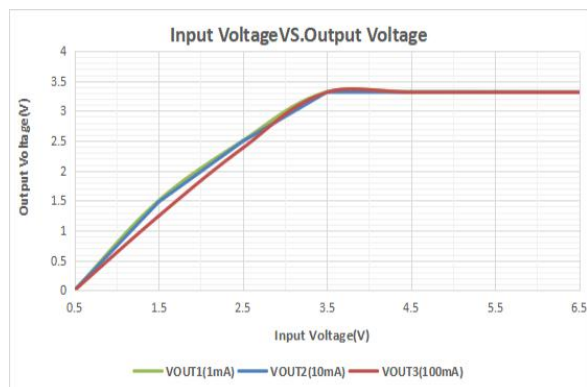
$V_{IN1}$  : Gradually reduce the input voltage, the input voltage when the output voltage drops to 98% of  $V_{OUT(E)}$ .

$V_{OUT(E)}' = V_{OUT(E)} \times 98\%$ .

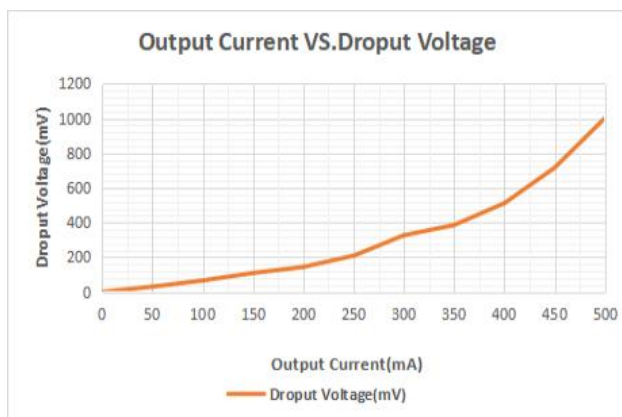
### Typical Operating Characteristics



**Output Current VS Output Voltage**

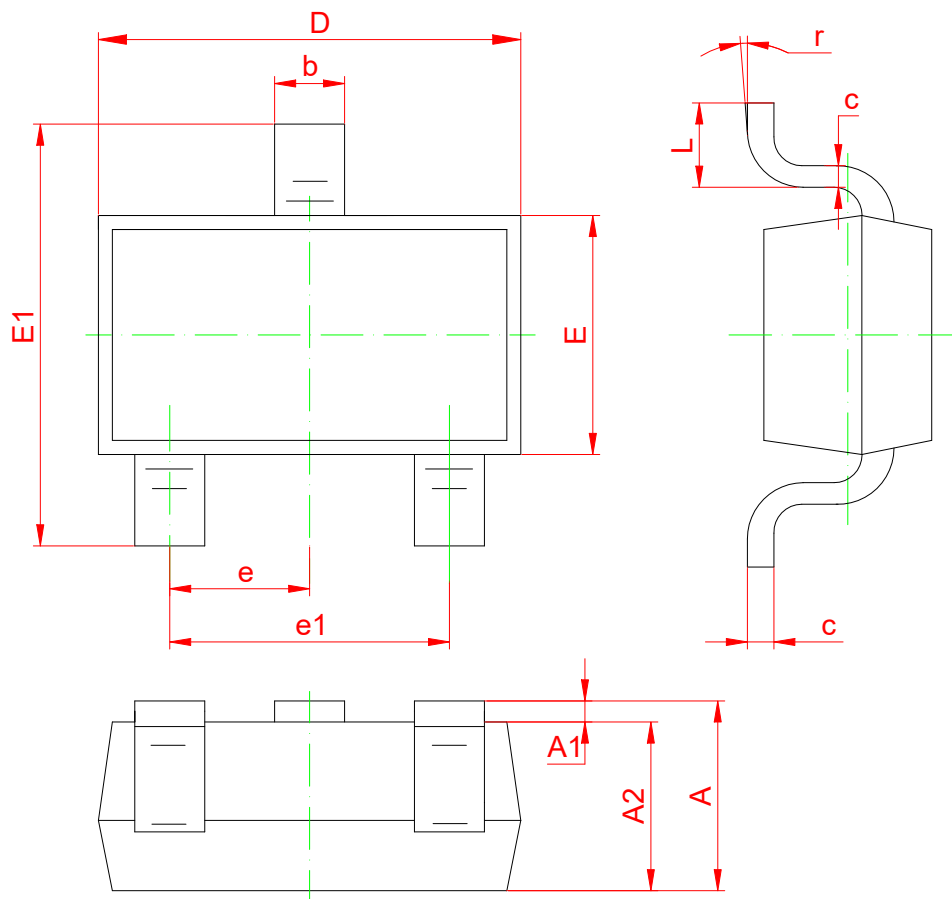


**Input Voltage VS Output Voltage**



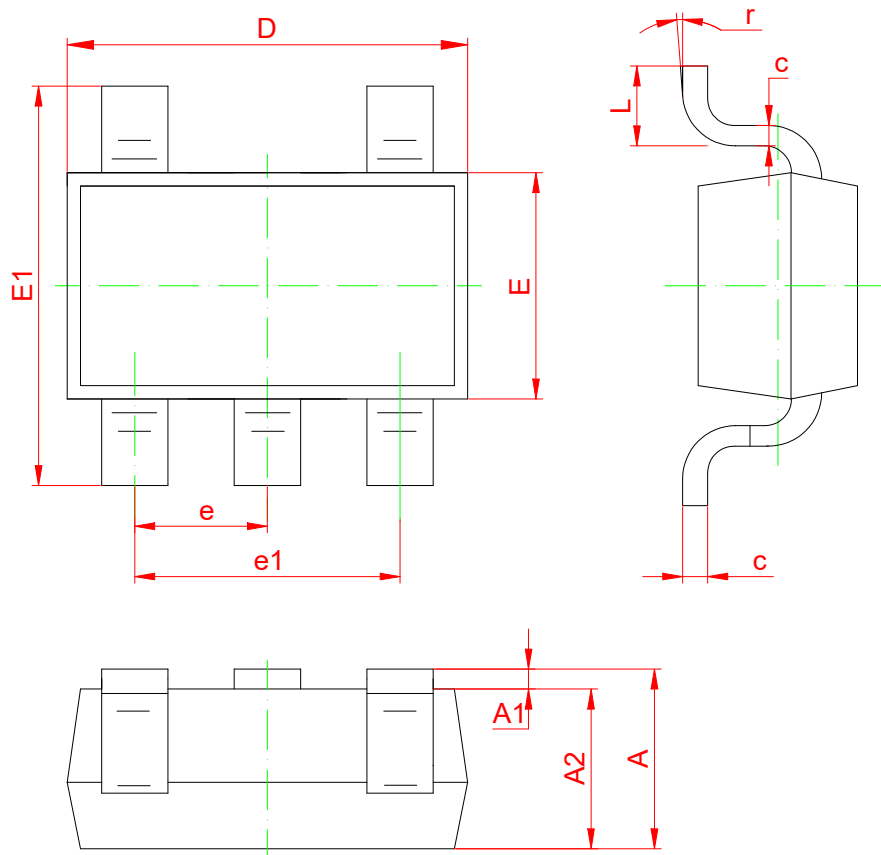
**Output Current VS Dropout Voltage**

### Package Outline: SOT-23-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 (BSC)		0.037 (BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
r	0°	8°	0°	8°

### Package Outline: SOT-23-5L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
<b>A</b>	<b>1.050</b>	<b>1.250</b>	<b>0.041</b>	<b>0.049</b>
<b>A1</b>	<b>0.000</b>	<b>0.100</b>	<b>0.000</b>	<b>0.004</b>
<b>A2</b>	<b>1.050</b>	<b>1.150</b>	<b>0.041</b>	<b>0.045</b>
<b>b</b>	<b>0.300</b>	<b>0.500</b>	<b>0.012</b>	<b>0.020</b>
<b>c</b>	<b>0.100</b>	<b>0.200</b>	<b>0.004</b>	<b>0.008</b>
<b>D</b>	<b>2.820</b>	<b>3.020</b>	<b>0.111</b>	<b>0.119</b>
<b>E</b>	<b>1.500</b>	<b>1.700</b>	<b>0.059</b>	<b>0.067</b>
<b>E1</b>	<b>2.650</b>	<b>2.950</b>	<b>0.104</b>	<b>0.116</b>
<b>e</b>	<b>0.950 (BSC)</b>		<b>0.037 (BSC)</b>	
<b>e1</b>	<b>1.800</b>	<b>2.000</b>	<b>0.071</b>	<b>0.079</b>
<b>L</b>	<b>0.300</b>	<b>0.600</b>	<b>0.012</b>	<b>0.024</b>
<b>r</b>	<b>0°</b>	<b>8°</b>	<b>0°</b>	<b>8°</b>



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